

QUALITY AND ENVIRONMENTAL POLICY

We produce and sell Bonding Wire and Micro Solder Ball in global semiconductor market and;

- 1. Provide the best service to customers while making profit for us and keep commitment to environment preservation for next generation.
- 2. Continually improve quality and cost of products with emphasis on prevention of pollution.
- 3. Regularly check performance based on customer and interested party requirements to ensure commitment to compliance.
- 4. Increase efficiency of work by setting right priorities and proposing new methods cooperated with NMC global team.
- 5. Make teamwork be more effective and always be ready for any change.

Mr. Akihito Nishibayashi President





